

HD74HC01

Quad. 2-input NAND Gates (with open drain outputs)

REJ03D0532-0200 (Previous ADE-205-404) Rev.2.00 Oct 06, 2005

Features

- High Speed Operation: $t_{pd} = 9$ ns typ ($C_L = 50$ pF)
- High Output Current: Fanout of 10 LSTTL Loads
- Wide Operating Voltage: $V_{CC} = 2 \text{ to } 6 \text{ V}$
- Low Input Current: 1 µA max
- Low Quiescent Supply Current: I_{CC} (static) = 1 μ A max (Ta = 25°C)
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC01P	DILP-14 pin	PRDP0014AB-B (DP-14AV)	Ρ	_
HD74HC01FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)
HD74HC01RPEL	SOP-14 pin (JEDEC)	PRSP0014DE-A (FP-14DNV)	RP	EL (2,500 pcs/reel)

Note: Please consult the sales office for the above package availability.

Function Table

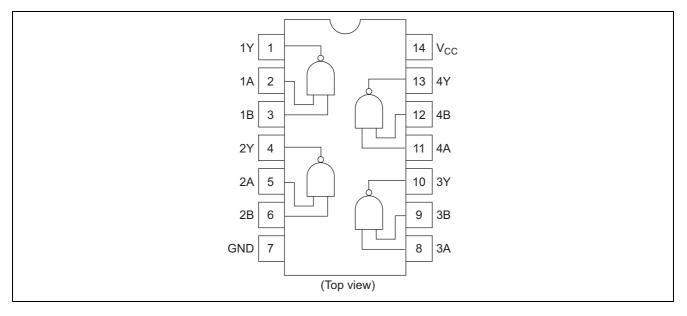
Function Table					
Inp	outs	Output			
A	В	Y			
L	L	н			
L	Н	Н			
Н	L	Н			
Н	Н	L			

H: High level

L: Low level



Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage range	V _{CC}	-0.5 to 7.0	V
Input / Output voltage	Vin, Vout	–0.5 to V _{CC} +0.5	V
Input / Output diode current	I _{IK} , I _{OK}	±20	mA
Output current	lo	±25	mA
V _{CC} , GND current	I _{CC} or I _{GND}	±50	mA
Power dissipation	PT	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

ltem	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{cc}	2 to 6	V	
Input / Output voltage	V _{IN} , V _{OUT}	0 to V _{CC}	V	
Operating temperature	Та	-40 to 85	°C	
		0 to 1000		V _{CC} = 2.0 V
Input rise / fall time ^{*1}	t _r , t _f	0 to 500	ns	$V_{CC} = 4.5 V$
		0 to 400		$V_{CC} = 6.0 V$

Note: 1. This item guarantees maximum limit when one input switches. Waveform: Refer to test circuit of switching characteristics.



			Т	a = 25°	С	Ta = -40	to+85°C		
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Input voltage	VIH	2.0	1.5	_	—	1.5	_	V	
		4.5	3.15	_	—	3.15	_		
		6.0	4.2	_	—	4.2	_		
	VIL	2.0	_	_	0.5	—	0.5	V	
		4.5	_	_	1.35	—	1.35		
		6.0	_	_	1.8	—	1.8		
Output voltage	V _{OL}	2.0	_	0.0	0.1	—	0.1	V	$Vin = V_{IH} \text{ or } V_{IL} I_{OL} = 20 \ \mu A$
		4.5	_	0.0	0.1	—	0.1		
		6.0	_	0.0	0.1	—	0.1		
		4.5	_	_	0.26	—	0.33		$I_{OL} = 4 \text{ mA}$
		6.0	_	_	0.26	—	0.33		I _{OL} = 5.2 mA
Off-state output	lo(off)	6.0	_	_	±0.5	—	±5.0	μA	$Vin = V_{IH} \text{ or } V_{IL},$
current									Vout = V_{CC} or GND
Input current	lin	6.0			±0.1	_	±1.0	μΑ	$Vin = V_{CC} \text{ or } GND$
Quiescent supply current	Icc	6.0		—	1.0		10	μA	Vin = V_{CC} or GND, lout = 0 μ A

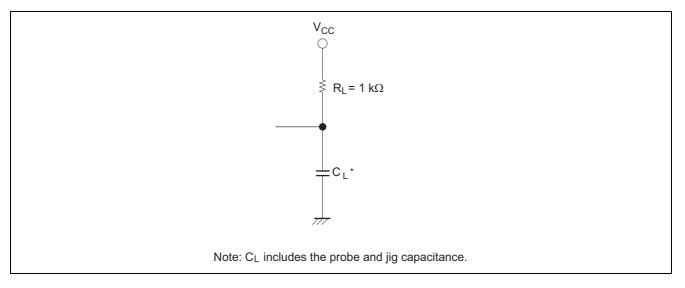
Electrical Characteristics

Switching Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

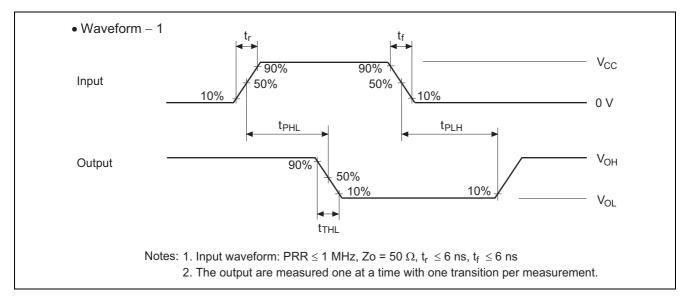
			Т	a = 25°	С	Ta = -40 to +85°C			
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Propagation delay	t _{PLH}	2.0	_	_	90	—	115	ns	
time		4.5	_	11	18	—	23		
		6.0	_	_	15	—	20		
	t _{PHL}	2.0	_	_	90	—	112	ns	
		4.5	_	7	18	—	22		
		6.0	_	_	15	—	18		
Output fall time	t⊤⊢∟	2.0	_	_	75	—	95	ns	
		4.5	_	5	15	—	19		
		6.0		_	13	—	16		
Input capacitance	Cin	—		5	10	—	10	pF	



Test Circuit

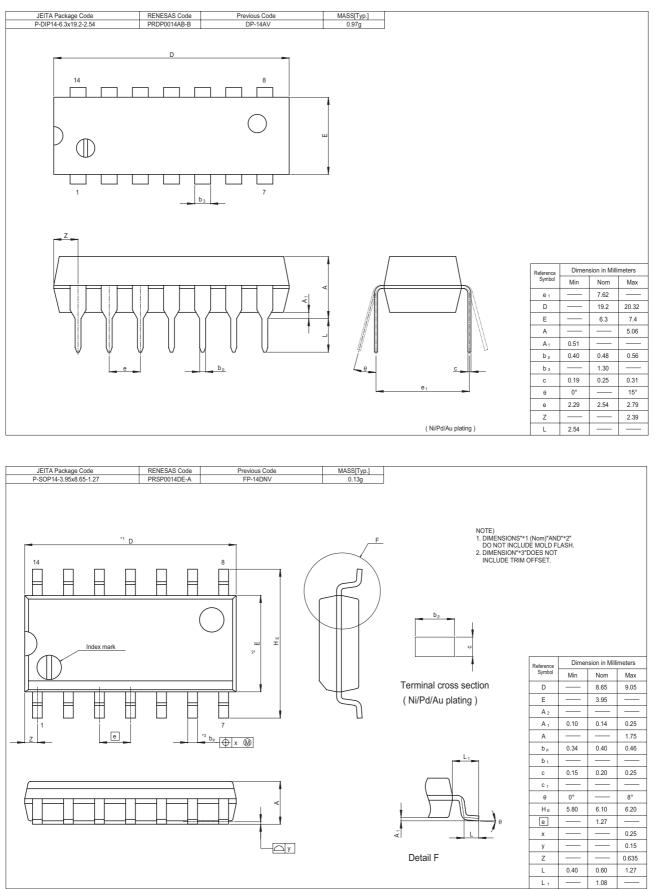


Waveforms



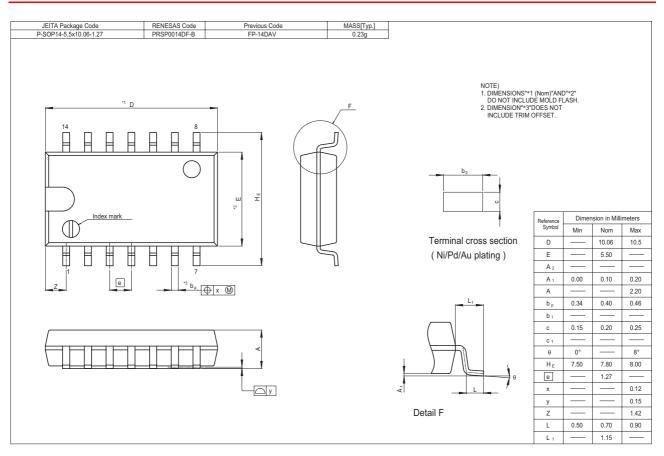


Package Dimensions





HD74HC01





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